

PCM CODEC

FEATURES

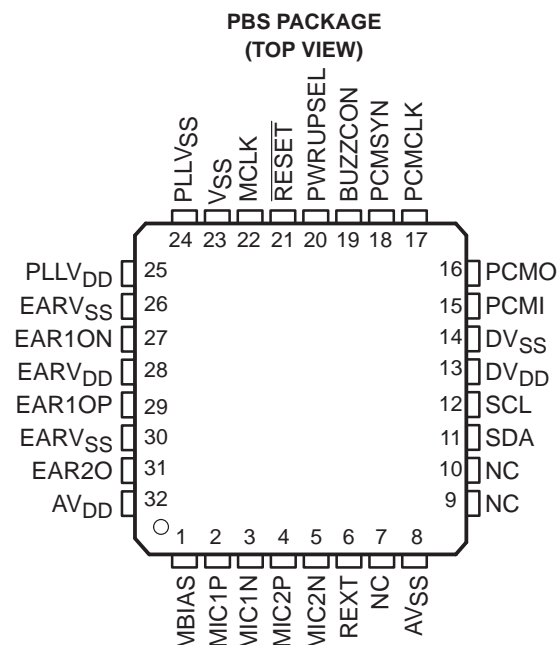
- **2.7-V Operation**
- **Two Differential Microphone Inputs, One Differential Earphone Output, and One Single-Ended Earphone Output**
- **Programmable Gain Amplifiers for Transmit, Receive, Sidetone, and Volume Control**
- **Earphone Mute and Microphone Mute**
- **On-Chip I²C-Bus, Which Provides a Simple, Standard, Two-Wire Serial Interface With Digital ICs**
- **Programmable for 15-Bit Linear Data or 8-Bit Companded (μ -Law or A-Law) Mode**
- **32-Terminal TQFP Package**
- **Designed for Analog and Digital Wireless Handsets and Telecommunications Applications**
- **Dual-Tone Multifrequency (DTMF)**
- **Pulse Density Modulated (PDM) Buzzer Output**

APPLICATIONS

- **Digital Handset**
- **Digital Headset**
- **Cordless Phones**
- **Digital PABX**
- **Digital Voice Recording**

DESCRIPTION

The PCM codec is designed to perform the transmit encoding analog/digital (A/D) conversion and receive decoding digital/analog (D/A) conversion, together with transmit and receive filtering, for voice-band communications systems. The device operates in either the 15-bit linear or 8-bit companded (μ -law or A-Law) mode, which is selectable through the I²C interface. From a 2.048-MHz master clock input, the PCM codec generates its own internal clocks.



NC – No internal connection

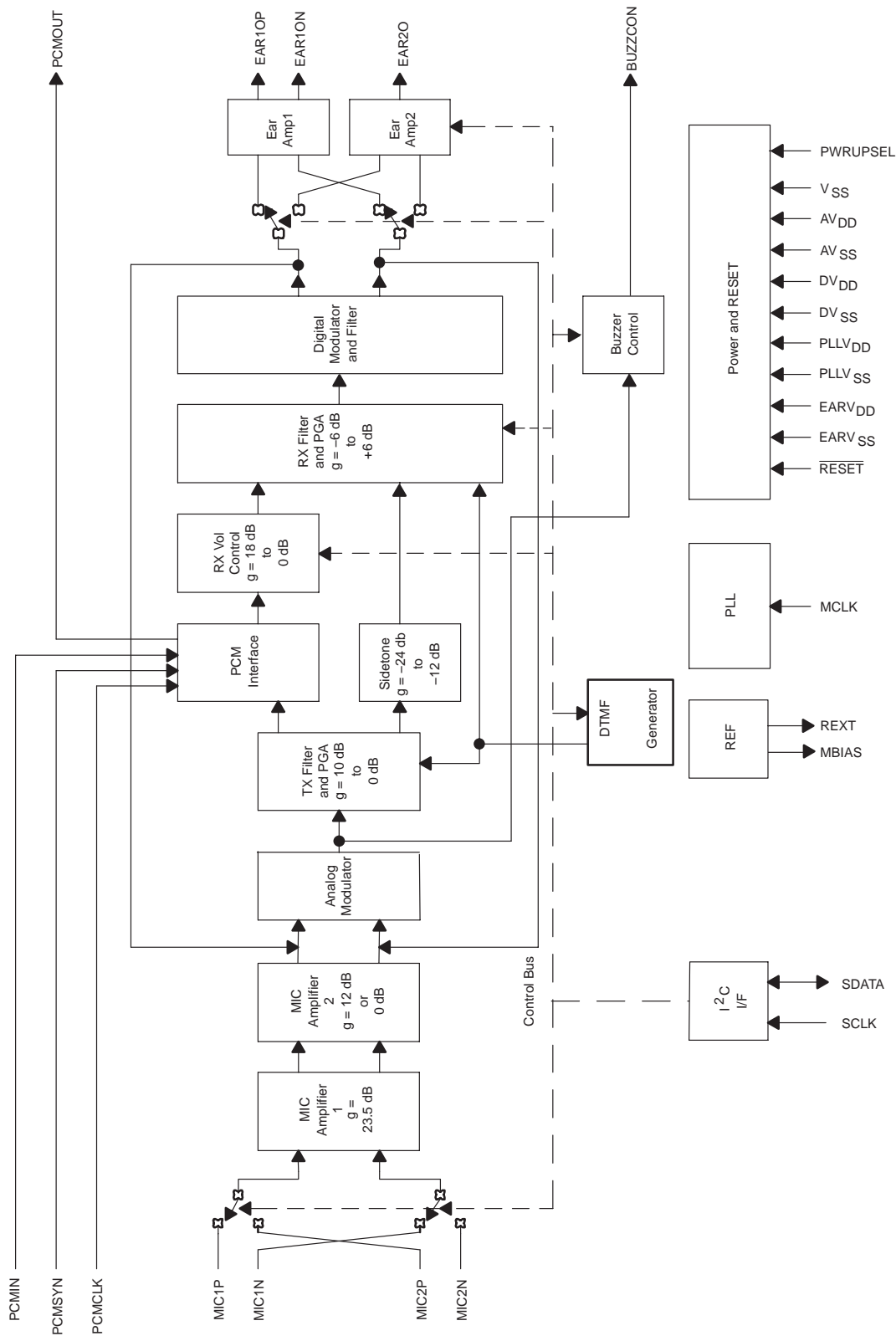


This device contains circuits to protect its inputs and outputs against damage due to high static voltages or electrostatic fields. These circuits have been qualified to protect this device against electrostatic discharges (ESD) of up to 2 kV according to MIL-STD-883C, Method 3015; however, it is advised that precautions be taken to avoid application of any voltage higher than maximum-rated voltages to these high-impedance circuits. During storage or handling, the device leads should be shorted together or the device should be placed in conductive foam. In a circuit, unused inputs should always be connected to an appropriated logic voltage level, preferably either V_{CC} or ground. Specific guidelines for handling devices of this type are contained in the publication *Guidelines for Handling Electrostatic-Discharge-Sensitive (ESDS) Devices and Assemblies* available from Texas Instruments.



Please be aware that an important notice concerning availability, standard warranty, and use in critical applications of Texas Instruments semiconductor products and disclaimers thereto appears at the end of this data sheet.

functional block diagram



functional description

power-on/reset

The power for the various digital and analog circuits is separated to improve the noise performance of the device. An external reset must be applied to the active low/RESET terminal to assure reset upon power on and to bring the device to an operational state. After the initial power-on sequence the TLV320AIC1109 can be functionally powered up and down by writing to the power control register through the I²C interface. The device has a pin selectable power-up in the default mode option. The hardwired pin-selectable PWRUPSEL function allows the PCM codec to power up in the default mode and to be used without a microcontroller.

reference

A precision band gap reference voltage is generated internally and supplies all required voltage references to operate the transmit and receive channels. The reference system also supplies bias voltage for use with an electret microphone at terminal MBIAS. An external precision resistor is required for reference current setting at terminal REXT.

control interface

The I²C interface is a two-wire bidirectional serial interface. The I²C interface controls the PCM codec by writing data to six control registers: 1) power control, 2) mode control, 3) transmit PGA and sidetone control, 4) receive PGA gain and volume control, 5) DTMF routing, and 6) tone selection control.

There are two power-up modes which may be selected at the PWRUPSEL terminal: 1) the PWRUPSEL state (V_{DD} at terminal 20) causes the device to power-up in the default mode when power is applied. Without an I²C interface or controlling device, the programmable functions will be fixed at the default gain levels and functions, such as the sidetone and DTF, will not be accessible. 2) The PWRUPSEL state (ground at terminal 20) causes the device to go to a power-down state when power is applied. In this mode an I²C interface is required to power up the device.

phase-locked loop

The internal digital filters and modulators require a 10.24-MHz clock that is generated by phase locking to the 2.048-MHz master clock input.

PCM interface

The PCM interface transmits and receives data at the PCMO and PCMI terminals respectively. The data is transmitted or received at the PCMCLK speed once every PCMSYN cycle. The PCMCLK may be tied directly to the 2.048-MHz master clock (MCLK). The PCMSYN can be driven by an external source or derived from the master clock and used as an interrupt to the host controller.

microphone amplifiers

The microphone input is a switchable interface for two differential microphone inputs. The first stage is a low noise differential amplifier that provides a gain of 23.5 dB. The second stage amplifier has a selectable gain of 0 dB or 12 dB.

analog modulator

The transmit channel modulator is a third-order sigma-delta design.

transmit filter and PGA

The transmit filter is a digital filter designed to meet CCITT G.714 requirements. The device operates in either the 15-bit linear or 8-bit companded μ -law or A-law mode that is selectable through the I²C interface. The transmit PGA defaults to 0 dB.

functional description (continued)**sidetone**

A portion of the transmitted audio is attenuated and fed back to the receive channel through the sidetone path. The sidetone path defaults to the mute condition. The default gain of -12 dB is set in the sidetone control register. The sidetone path can be enabled by writing to the power control register.

receive volume control

The receive volume control block acts as an attenuator with a range of -18 dB to 0 dB in 2 dB steps for control of the receive channel volume. The receive volume control gain defaults to 0 dB.

receive filter and PGA

The receive filter is a digital filter that meets CCITT G.714 requirements with a high-pass filter that is selectable through the I²C interface. The device operates in either the 15-bit linear or 8-bit μ -law or A-law companded mode, which is selectable through the I²C interface. The gain defaults to -1 dB representing a 3 dBm₀ level for a 32 Ω to 110 Ω load impedance and the corresponding digital full scale PCMI code of -4 dB.

digital modulator and filter

The second-order digital modulator and filter convert the received digital PCM data to the analog output required by the earphone interface.

earphone amplifiers

The analog signal can be routed to either of two earphone amplifiers, one with differential output (EAR1ON and EAR1OP) and one with single-ended output (EAR2O). Clicks and pops are suppressed for EAR1 differential output only.

tone generator

The tone generator provides generation of standard DTMF tones which are output to one of the following: 1) the buzzer driver, as a pulse density modulation (PDM) signal, or 2) the receive path digital/analog converter (D/A), for outputting through the earphone or as PCMO data. The integer value is loaded into one of two 8-bit registers, the high tone register [04} or the low tone register {05}. The tone output is 2 dB higher when applied to the high tone register {04}. The high DTMF tones must be applied to the high tone register, and the low DTMF tones to the low tone register.

Terminal Functions

| TERMINAL | | I/O | DESCRIPTION |
|---------------------------|-------------|-----|---|
| NAME | NO. TQFP | | |
| AV _{DD} | 32 | I | Analog positive power supply |
| AV _{SS} | 8 | I | Analog negative power supply |
| BUZZCON | 19 | O | Buzzer output, a pulse-density modulated signal to apply to external buzzer driver |
| DV _{DD} | 13 | I | Digital positive power supply |
| DV _{SS} | 14 | I | Digital negative power supply |
| EAR1ON | 27 | O | Earphone 1 amplifier output (–) |
| EAR1OP | 29 | O | Earphone 1 amplifier output (+) |
| EAR2O | 31 | O | Earphone 2 amplifier output |
| EARV _{DD} | 28 | I | Analog positive power supply for the earphone amplifiers |
| EARV _{SS} | 30, 26 | I | Analog negative power supply for the earphone amplifiers |
| MBIAS | 1 | O | Microphone bias supply output, no decoupling capacitors |
| MCLK | 22 | I | Master system clock input (2.048 MHz) (digital) |
| MIC1P | 2 | I | MIC1 input (+) |
| MIC1N | 3 | I | MIC1 input (–) |
| MIC2P | 4 | I | MIC2 input (+) |
| MIC2N | 5 | I | MIC2 input (–) |
| PCMI | 15 | I | Receive PCM input |
| PCMO | 16 | O | Transmit PCM output |
| PCMSYN | 18 | I | PCM frame sync |
| PCMCLK | 17 | I | PCM data clock |
| PLL _{VSS} | 24 | I | PLL negative power supply |
| PLL _{VDD} | 25 | I | PLL digital power supply |
| PWRUPSEL | 20 | I | Selects the power-up default mode |
| REXT | 6 | I/O | Internal reference current setting terminal. This terminal uses a precision 100-kΩ resistor and no filtering capacitors. |
| $\overline{\text{RESET}}$ | 21 | I | Active low reset |
| SCL | 12 | I | I ² C-bus serial clock. This input is used to synchronize the data transfer from and to the PCM codec. |
| SDA | 11 | I/O | I ² C-bus serial address/data input/output. This is a bidirectional terminal used to transfer register control addresses and data into and out of the codec. It is an open-drain terminal and therefore requires a pullup resistor to V _{DD} (typical 10 kΩ for 100 kHz). |
| V _{SS} | 23 | I | Ground return for bandgap internal reference |

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)[†]

| | |
|---|------------------------------|
| Supply voltage range | –0.5 V to 4 V |
| Output voltage range | –0.5 V to 4 V |
| Input voltage range | –0.5 V to 4 V |
| Continuous total power dissipation | See Dissipation Rating Table |
| Operating free air temperature range (industrial temperature) | –40°C to 85°C |
| Storage temperature range, testing | –65°C to 150°C |
| Lead temperature 1,6 mm from case for 10 seconds | 260°C |

[†] Stresses beyond those listed under “absolute maximum ratings” may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under “recommended operating conditions” is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

DISSIPATION RATING TABLE

| PACKAGE | $T_A \leq 25^\circ\text{C}$ POWER RATING | DERATING FACTOR ABOVE $T_A = 25^\circ\text{C}$ | $T_A = 85^\circ\text{C}$ POWER RATING |
|---------|---|---|--|
| PBS | 702 mW | 7.2 mW/ $^\circ\text{C}$ | 270 mW |

recommended operating conditions (see Notes 1 and 2)

| | MIN | NOM | MAX | UNIT |
|---|---------------------|-----------|---------------------|------------------|
| Supply voltage, AV_{DD} , DV_{DD} , PLL_{VDD} , EAR_{VDD} | 2.7 | | 3.3 | V |
| High-level input voltage (V_{IHMIN}) | $0.7 \times V_{DD}$ | | | V |
| Low-level input voltage (V_{ILMAX}) | | | $0.3 \times V_{DD}$ | V |
| Load impedance between $EAR1OP$ and $EAR1ON-R_L$ | | 32 to 110 | | Ω |
| Load impedance for $EAR2OP-R_L$ | | 32 | | Ω |
| Operating free-air temperature, T_A | -40 | | 85 | $^\circ\text{C}$ |

NOTES: 1. To avoid possible damage and resulting reliability problems to these CMOS devices, the *power-on initialization* paragraph should be followed, described in the *Principles of Operations*.

2. Voltages are with respect to AV_{SS} , DV_{SS} , PLL_{VSS} and EAR_{VSS} .

electrical characteristics over recommended ranges of supply voltage and free air temperature (unless otherwise noted)**supply current**

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|--|-----|-----|-----|---------------|
| I_{DD} Supply current from V_{DD} | Operating, $EAR1$ selected, MicBias disabled | | 6 | 8 | mA |
| | Operating, $EAR2$ selected, MicBias disabled | | 5.4 | 7 | mA |
| | Power down, Reg 2 bit 7 = 1, MCLK not present (see Note 3) | | 0.5 | 35 | μA |
| | Power down, Reg 2 bit 7 = 0, MCLK not present (see Note 3) | | 25 | 75 | μA |
| $t_{on(i)}$ Power-up time from power down | | | 5 | 10 | ms |

NOTE 3: Measured while $MIC1P$ and $MIC1N$ are connected together. Less than 5 mV offset results in 0 value code on $PCMOUT$.

digital interface

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--|---|-------------------|-----|------|---------------|
| V_{OH} High-level output voltage PCMO (BUZZCON) | $I_{OH} = -3.2\text{ mA}$, $V_{DD} = 3\text{ V}$ | $DV_{DD} = -0.25$ | | | V |
| V_{OL} Low-level output voltage PCMO | $I_{OL} = 3.2\text{ mA}$, $V_{DD} = 3\text{ V}$ | | | 0.25 | V |
| I_{IH} High-level input current, any digital input | $V_I = V_{DD}$ | | | 10 | μA |
| I_{IL} Low-level input current, any digital input | $V_I = V_{SS}$ | | | 10 | μA |
| C_I Input capacitance | | | | 10 | pF |
| C_O Output capacitance | | | | 20 | pF |
| R_L Load impedance (BUZZCON) | | | | 5 | k Ω |

electrical characteristics over recommended ranges of supply voltage and free air temperature (unless otherwise noted) (continued)

microphone interface

| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---------------|---|---|------|-----|------|---------------|
| V_{IO} | Input offset voltage at MIC1N, MIC2N | See Note 3 | –5 | | 5 | mV |
| I_{IB} | Input bias current at MIC1N, MIC2N | | –250 | | 250 | nA |
| C_i | Input capacitance at MIC1N, MIC2N | | | 5 | | pF |
| V_n | Microphone input referred noise, psophometric weighted, (C-message weighted is similar) | Micamp 1 gain = 23.5 dB Micamp 2 gain = 0 dB | | 3 | 7.7 | μV_{rms} |
| I_{Omax} | Output source current – MBIAS | | 1 | | 1.2 | mA |
| $V_{(mbias)}$ | Microphone bias supply voltage (see Note 4) | | 2.4 | 2.5 | 2.55 | V |
| | MICMUTE | | –80 | | | dB |
| | Input impedance | Fully differential | 35 | 60 | 100 | k Ω |

NOTES: 3. Measured while MIC1P and MIC1N are connected together. Less than 5-mV offset results in 0 value code on PCMOUT.

4. Not a JEDEC symbol

speaker interface

| PARAMETER | | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|---------------------------------------|---|-----|---------|----------|------|
| Earphone AMP1 output power (See Note 5) | | Fully differential, 110- Ω load, 3-dBm0 output, RGXPA = –4 dB | | 23.4 | 31.2 | mW |
| | | V_{DD} = 2.7 V, fully differential, 32- Ω load, 3-dBm0 output, RGXPA = –4 dB | | 80.5 | 107.3 | mW |
| Earphone AMP2 output power (See Note 5) | | V_{DD} = 2.7 V, single ended, 32- Ω load, 3-dBm0 output | | 10 | 12.5 | mW |
| V_{OO} | Output offset voltage at EAR1 | Fully differential | | ± 5 | ± 30 | mV |
| I_{Omax} | Maximum output current for EAR1(rms) | 3-dBm0 input, 110- Ω load | | 14.6 | 19.4 | mA |
| | | 3-dBm0 input, 32- Ω load | | 50.2 | 66.9 | |
| | Maximum output current for EAR2 (rms) | 3-dBm0 input | | 17.7 | 22.1 | |
| EARMUTE | | | –80 | | | dB |

NOTE 5: Maximum power is with a load impedance of –25%.

transmit gain and dynamic range, companded mode (μ -law or A-law) or linear mode selected, transmit slope filter bypassed (see Notes 6 and 7)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|--|------|-----|-----|------------------|
| Transmit reference-signal level (0dB) | Differential | | | 175 | mV _{pp} |
| Overload-signal level (3 dBm0) | Differential, normal mode | | | 248 | mV _{pp} |
| | Differential, extended mode | | | 63 | |
| Absolute gain error | 0 dBm0 input signal, $V_{DD} \pm 10\%$ | –1 | | 1 | dB |
| Gain error with input level relative to gain at –10 dBm0 MIC1N, MIC1P to PCMO | MIC1N, MIC1P to PCMO at 3 dBm0 to –30 dBm0 | –0.5 | | 0.5 | dB |
| | MIC1N, MIC1P to PCMO at –31 dBm0 to –45 dBm0 | –1 | | 1 | |
| | MIC1N, MIC1P to PCMO at –46 dBm0 to –55 dBm0 | –1.2 | | 1.2 | |

NOTES: 6. Unless otherwise noted, the analog input is 0 dB, 1020-Hz sine wave, where 0 dB is defined as the zero-reference point of the channel under test.

7. The reference signal level, which is input to the transmit channel, is defined as a value 3 dB below the full-scale value of 88-mV_{rms}.

electrical characteristics over recommended ranges of supply voltage and free air temperature (unless otherwise noted) (continued)

transmit gain and dynamic range, companded mode (μ -law or A-law) or linear mode selected, transmit slope filter enabled (see Notes 6 and 7)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|---|------|-----|-----|------------------|
| Transmit reference-signal level (0dB) | Differential | | | 175 | mV _{pp} |
| Overload-signal level (3 dBm0) | Differential, normal mode | | | 248 | mV _{pp} |
| | Differential, extended mode | | | 63 | |
| Absolute gain error | 0 dBm0 input signal, V _{DD} \pm 10 % | -1 | | 1 | dB |
| Gain error with input level relative to gain at -10 dBm0 MIC1N, MIC1P to PCMO | MIC1N, MIC1P to PCMO at 3 dBm0 to -30 dBm0 | -0.5 | | 0.5 | dB |
| | MIC1N, MIC1P to PCMO at -31 dBm0 to -45 dBm0 | -1 | | 1 | |
| | MIC1N, MIC1P to PCMO at -46 dBm0 to -55 dBm0 | -1.2 | | 1.2 | |

NOTES: 6. Unless otherwise noted, the analog input is 0 dB, 1020-Hz sine wave, where 0 dB is defined as the zero-reference point of the channel under test.

7. The reference signal level, which is input to the transmit channel, is defined as a value 3 dB below the full-scale value of 88-mV_{rms}.

transmit filter transfer, companded mode (μ -law or A-law) or linear mode selected, transmit slope filter bypassed, external high-pass filter bypassed (MCLK = 2.048 MHz)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--|--|------|-----|-----|------|
| Gain relative to input signal gain at 1020 Hz, internal high-pass filter disabled. | f _{MIC1} or f _{MIC2} <100 Hz | -0.5 | | 0.5 | dB |
| | f _{MIC1} or f _{MIC2} = 200 Hz | -0.5 | | 0.5 | |
| | f _{MIC1} or f _{MIC2} = 300 Hz to 3 kHz | -0.5 | | 0.5 | |
| | f _{MIC1} or f _{MIC2} = 3.4 kHz | -1.5 | | 0 | |
| | f _{MIC1} or f _{MIC2} = 4 kHz | | | -14 | |
| | f _{MIC1} or f _{MIC2} = 4.6 kHz | | | -35 | |
| | f _{MIC1} or f _{MIC2} = 8 k Hz | | | -47 | |
| Gain relative to input signal gain at 1020 Hz, internal high-pass filter enabled. | f _{MIC1} or f _{MIC2} <100 Hz | | | -15 | dB |
| | f _{MIC1} or f _{MIC2} = 200 Hz | | | -5 | |

electrical characteristics over recommended ranges of supply voltage and free air temperature (unless otherwise noted) (continued)

transmit filter transfer, companded mode (μ -law or A-law) or linear mode selected, transmit slope filter selected, transmit high-pass filter disabled (MCLK = 2.048 MHz) (see Note 8)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|------------------------------------|-----|-------|-----|------|
| Gain relative to input signal gain at 1.2 kHz, with slope filter selected | f_{MIC1} or f_{MIC2} = 100 Hz | | | -27 | dB |
| | f_{MIC1} or f_{MIC2} = 200 Hz | | | -8 | dB |
| | f_{MIC1} or f_{MIC2} = 250 Hz | | | -4 | dB |
| | f_{MIC1} or f_{MIC2} = 300 Hz | | -1.8 | | dB |
| | f_{MIC1} or f_{MIC2} = 400 Hz | | -1.5 | | dB |
| | f_{MIC1} or f_{MIC2} = 500 Hz | | -1.3 | | dB |
| | f_{MIC1} or f_{MIC2} = 600 Hz | | -1.1 | | dB |
| | f_{MIC1} or f_{MIC2} = 700 Hz | | -0.8 | | dB |
| | f_{MIC1} or f_{MIC2} = 800 Hz | | -0.57 | | dB |
| | f_{MIC1} or f_{MIC2} = 900 Hz | | -0.25 | | dB |
| | f_{MIC1} or f_{MIC2} = 1000 Hz | | 0 | | dB |
| | f_{MIC1} or f_{MIC2} = 1500 Hz | | 1.8 | | dB |
| | f_{MIC1} or f_{MIC2} = 2000 Hz | | 4 | | dB |
| | f_{MIC1} or f_{MIC2} = 2500 Hz | | 6.5 | | dB |
| | f_{MIC1} or f_{MIC2} = 3000 Hz | | 7.6 | | dB |
| | f_{MIC1} or f_{MIC2} = 3100 Hz | | 7.7 | | dB |
| | f_{MIC1} or f_{MIC2} = 3300 Hz | | 8 | | dB |
| | f_{MIC1} or f_{MIC2} = 3500 Hz | | 6.48 | | dB |
| | f_{MIC1} or f_{MIC2} = 4000 Hz | | | -13 | dB |
| | f_{MIC1} or f_{MIC2} = 4500 Hz | | | -35 | dB |
| | f_{MIC1} or f_{MIC2} = 5000 Hz | | | -45 | dB |
| | f_{MIC1} or f_{MIC2} = 8000 Hz | | | -50 | dB |

NOTE 8: The pass-band tolerance is ± 0.25 dB from 300 Hz to 3500 Hz.

transmit idle channel noise and distortion, companded mode (μ -law or A-law) selected, slope filter bypassed

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--|--|-----|-------|-----|-------------------|
| Transmit idle channel noise, psophometrically weighted | TXPGA gain = 0 dB, micamp 1 gain = 23.5 dB, micamp 2 gain = 0 dB | | -86.6 | -78 | dBm _{0p} |
| Transmit signal-to-distortion ratio with 1020-Hz sine-wave input | MIC1N, MIC1P to PCMO at 3 dBm ₀ | 27 | | | dBm ₀ |
| | MIC1N, MIC1P to PCMO at 0 dBm ₀ | 30 | | | |
| | MIC1N, MIC1P to PCMO at -5 dBm ₀ | 33 | | | |
| | MIC1N, MIC1P to PCMO at -10 dBm ₀ | 36 | | | |
| | MIC1N, MIC1P to PCMO at -20 dBm ₀ | 35 | | | |
| | MIC1N, MIC1P to PCMO at -30 dBm ₀ | 26 | | | |
| | MIC1N, MIC1P to PCMO at -40 dBm ₀ | 24 | | | |
| | MIC1N, MIC1P to PCMO at -45 dBm ₀ | 19 | | | |
| Intermodulation distortion, 2-tone CCITT method, composite power level, -13 dBm ₀ | CCITT G.712 (7.1), R2 | 49 | | | dB |
| | CCITT G.712 (7.2), R2 | 51 | | | |

electrical characteristics over recommended ranges of supply voltage and free air temperature (unless otherwise noted) (continued)

transmit idle channel noise and distortion, companded mode (μ -law or A-law) selected, slope filter enabled

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--|--|-----|-------|-----|-------------------|
| Transmit idle channel noise, psophometrically weighted | TXPGA gain = 0 dB, micamp 1 gain = 23.5 dB, micamp 2 gain = 0.0 dB | | -86.6 | -78 | dBm _{0p} |
| Transmit signal-to-total distortion ratio with 1020-Hz sine-wave input | MIC1N, MIC1P to PCMO at 3 dBm ₀ | 27 | | | dBm ₀ |
| | MIC1N, MIC1P to PCMO at 0 dBm ₀ | 30 | | | |
| | MIC1N, MIC1P to PCMO at -5 dBm ₀ | 33 | | | |
| | MIC1N, MIC1P to PCMO at -10 dBm ₀ | 36 | | | |
| | MIC1N, MIC1P to PCMO at -20 dBm ₀ | 35 | | | |
| | MIC1N, MIC1P to PCMO at -30 dBm ₀ | 26 | | | |
| | MIC1N, MIC1P to PCMO at -40 dBm ₀ | 24 | | | |
| | MIC1N, MIC1P to PCMO at -45 dBm ₀ | 19 | | | |
| Intermodulation distortion, 2-tone CCITT method, composite power level, -13 dBm ₀ | CCITT G.712 (7.1), R2 | 49 | | | dB |
| | CCITT G.712 (7.2), R2 | 51 | | | |

transmit idle channel noise and distortion, linear mode selected, slope filter bypassed

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--|--|-----|-------|-----|-------------------|
| Transmit idle channel noise | TXPGA gain = 0 dB, micamp 1 gain = 23.5 dB, micamp 2 gain = 0.0 dB | | -86.6 | -78 | dBm _{0p} |
| Transmit signal-to-total distortion ratio with 1020-Hz sine-wave input | MIC1N, MIC1P to PCMO at 3 dBm ₀ | 50 | 50 | | dB |
| | MIC1N, MIC1P to PCMO at 0 dBm ₀ | 50 | 65 | | |
| | MIC1N, MIC1P to PCMO at -5 dBm ₀ | 60 | 68 | | |
| | MIC1N, MIC1P to PCMO at -10 dBm ₀ | 64 | 70 | | |
| | MIC1N, MIC1P to PCMO at -20 dBm ₀ | 58 | 65 | | |
| | MIC1N, MIC1P to PCMO at -30 dBm ₀ | 50 | 60 | | |
| | MIC1N, MIC1P to PCMO at -40 dBm ₀ | 38 | 50 | | |
| | MIC1N, MIC1P to PCMO at -45 dBm ₀ | 30 | 45 | | |

transmit idle channel noise and distortion, linear mode selected, slope filter enabled

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--|--|-----|-------|-----|-------------------|
| Transmit idle channel noise | TXPGA gain = 0 dB, micamp 1 gain = 23.5 dB, micamp 2 gain = 0 dB | | -86.6 | -78 | dBm _{0p} |
| Transmit signal-to-total distortion ratio with 1020-Hz sine-wave input | MIC1N, MIC1P to PCMO at 3 dBm ₀ | 40 | 50 | | dB |
| | MIC1N, MIC1P to PCMO at 0 dBm ₀ | 50 | 65 | | |
| | MIC1N, MIC1P to PCMO at -5 dBm ₀ | 50 | 68 | | |
| | MIC1N, MIC1P to PCMO at -10 dBm ₀ | 64 | 70 | | |
| | MIC1N, MIC1P to PCMO at -20 dBm ₀ | 58 | 65 | | |
| | MIC1N, MIC1P to PCMO at -30 dBm ₀ | 50 | 60 | | |
| | MIC1N, MIC1P to PCMO at -40 dBm ₀ | 38 | 50 | | |
| | MIC1N, MIC1P to PCMO at -45 dBm ₀ | 30 | 45 | | |

electrical characteristics over recommended ranges of supply voltage and free air temperature (unless otherwise noted) (continued)

receive gain and dynamic range, EAR1 selected, linear or companded (μ -law or A-law) mode selected (see Note 9)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|---|------|------|-----|----------|
| Overload-signal level (3.0 dB) | 110 Ω load RXPGA = -4 dB | | 4.54 | | V_{pp} |
| | 32 Ω load RXPGA = -4 dB | | 4.54 | | |
| Absolute gain error | 0 dBm0 input signal, $V_{DD} \pm 10\%$ | -1 | | 1 | dB |
| Gain error with output level relative to gain at -10 dBm0 | PCMIN to EAR1ON, EAR1OP at 3 dBm0 to -40 dBm0 | -0.5 | | 0.5 | dB |
| | PCMIN to EAR1ON, EAR1OP at -41 dBm0 to -50 dBm0 | -1 | | 1 | |
| | PCMIN to EAR1ON, EAR1OP at -51 dBm0 to -55 dBm0 | -1.2 | | 1.2 | |

NOTE 9: RXPGA = -4 dB for 32 Ω or 110 Ω , RXVOL = 0 dB, 1020 Hz input signal at PCMI, output measured differentially between EAR1ON and EAR1OP

receive gain and dynamic range, EAR2 selected, linear or companded (μ -law or A-law) mode selected (see Note 10)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|--|------|-----|-----|----------|
| Receive reference-signal level (0 dB) | 0 dBm0 PCM input signal | | 1.1 | | V_{pp} |
| Overload-signal level (3 dB) | | | 1.6 | | V_{pp} |
| Absolute gain error | 0 dBm0 input signal, $V_{DD} \pm 10\%$ | -1 | | 1 | dB |
| Gain error with output level relative to gain at -10 dBm0 | PCMIN to EAR2O at 3 dBm0 to -40 dBm0 | -0.5 | | 0.5 | dB |
| | PCMIN to EAR2O at -41 dBm0 to -50 dBm0 | -1 | | 1 | |
| | PCMIN to EAR2O at -51 dBm0 to -55 dBm0 | -1.2 | | 1.2 | |

NOTE 10: RXPGA = -1 dB, RXVOL = 0 dB

receive filter transfer, companded mode (μ -law or A-law) or linear mode selected (MCLK = 2.048 MHz) (see Note 10)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|--|------|-----|-----|------|
| Gain relative to input signal gain at 1020 Hz, internal high-pass filter disabled | f_{EAR1} or $f_{EAR2} < 100$ Hz | -0.5 | | 0.5 | dB |
| | f_{EAR1} or $f_{EAR2} = 200$ Hz | -0.5 | | 0.5 | |
| | f_{EAR1} or $f_{EAR2} = 300$ Hz to 3 kHz | -0.5 | | 0.5 | |
| | f_{EAR1} or $f_{EAR2} = 3.4$ kHz | -1.5 | | 0 | |
| | f_{EAR1} or $f_{EAR2} = 4$ kHz | | | -14 | |
| | f_{EAR1} or $f_{EAR2} = 4.6$ kHz | | | -35 | |
| | f_{EAR1} or $f_{EAR2} = 8$ kHz | | | -47 | |
| Gain relative to input signal gain at 1020 Hz, internal high-pass filter enabled | f_{EAR1} or $f_{EAR2} < 100$ Hz | | | -15 | dB |
| | f_{EAR1} or $f_{EAR2} = 200$ Hz | | | -5 | |

NOTE 10. RXPGA = -1 dB, RXVOL = 0 dB

electrical characteristics over recommended ranges of supply voltage and free air temperature (unless otherwise noted) (continued)

receive idle channel noise and distortion, EAR1 selected, companded mode (μ -law or A-law) selected (see Note 9)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|-------------------------------------|-----|-----|-----|------------------------|
| Receive noise, psophometrically weighted | PCMIN = 11010101 (A-law) | | -89 | -86 | dBm _{0p} |
| Receive noise, C-message weighted | PCMIN = 11111111 (μ -law) | | 36 | 50 | μ V _{rms} |
| Receive signal-to-distortion ratio with 1020-Hz sine-wave input | PCMIN to EAR1ON, EAR1OP at 3 dBm0 | 21 | | | dB |
| | PCMIN to EAR1ON, EAR1OP at 0 dBm0 | 25 | | | |
| | PCMIN to EAR1ON, EAR1OP at -5 dBm0 | 36 | | | |
| | PCMIN to EAR1ON, EAR1OP at -10 dBm0 | 43 | | | |
| | PCMIN to EAR1ON, EAR1OP at -20 dBm0 | 40 | | | |
| | PCMIN to EAR1ON, EAR1OP at -30 dBm0 | 38 | | | |
| | PCMIN to EAR1ON, EAR1OP at -40 dBm0 | 28 | | | |
| | PCMIN to EAR1ON, EAR1OP at -45 dBm0 | 23 | | | |

NOTE 9: RXPGA = -4 dB for 32 Ω or 110 Ω , RXVOL = 0 dB, 1020-Hz input signal at PCMI, output measured differentially between EAR1ON and EAR1OP.

receive idle channel noise and distortion, EAR1 selected, linear mode selected (see Note 9)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--|-------------------------------------|-----|-----|-----|------|
| Receive noise, (20-Hz to 20-kHz brickwall window) | PCMIN = 000000000000 | | -86 | -83 | dBm0 |
| Receive signal-to-distortion ratio with 1020 Hz sine-wave input | PCMIN to EAR1ON, EAR1OP at 3 dBm0 | 50 | 63 | | dB |
| | PCMIN to EAR1ON, EAR1OP at 0 dBm0 | 53 | 65 | | |
| | PCMIN to EAR1ON, EAR1OP at -5 dBm0 | 53 | 63 | | |
| | PCMIN to EAR1ON, EAR1OP at -10 dBm0 | 50 | 60 | | |
| | PCMIN to EAR1ON, EAR1OP at -20 dBm0 | 48 | 58 | | |
| | PCMIN to EAR1ON, EAR1OP at -30 dBm0 | 46 | 56 | | |
| | PCMIN to EAR1ON, EAR1OP at -40 dBm0 | 36 | 52 | | |
| | PCMIN to EAR1ON, EAR1OP at -45 dBm0 | 30 | 50 | | |
| Intermodulation distortion, 2-tone CCITT method, composite power level, -13 dBm0 | CCITT G.712 (7.1), R2 | 50 | | | dB |
| | CCITT G.712 (7.2), R2 | 54 | | | |

NOTE 9: RXPGA = -4 dB for 32 Ω or 110 Ω , RXVOL = 0 dB, 1020-Hz input signal at PCMI, output measured differentially between EAR1ON and EAR1OP.

receive idle channel noise and distortion EAR2 selected, companded mode (μ -law or A-law) selected (see Note 10)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|--------------------------------|-----|-----|-----|------------------------|
| Receive noise, psophometrically weighted | PCMIN = 11010101 (A-law) | | -81 | -78 | dBm _{0p} |
| Receive noise, C-message weighted | PCMIN = 11111111 (μ -law) | | 36 | 50 | μ V _{rms} |
| Receive signal-to-distortion ratio with 1020-Hz sine-wave input | PCMIN to EAR2O at 3 dBm0 | 21 | | | dB |
| | PCMIN to EAR2O at 0 dBm0 | 25 | | | |
| | PCMIN to EAR2O at -5 dBm0 | 36 | | | |
| | PCMIN to EAR2O at -10 dBm0 | 43 | | | |
| | PCMIN to EAR2O at -20 dBm0 | 40 | | | |
| | PCMIN to EAR2O at -30 dBm0 | 38 | | | |
| | PCMIN to EAR2O at -40 dBm0 | 28 | | | |
| | PCMIN to EAR2O at -45 dBm0 | 23 | | | |

NOTE 10: RXPGA = -1 dB, RXVOL = 0 dB

electrical characteristics over recommended ranges of supply voltage and free air temperature (unless otherwise noted) (continued)

receive idle channel noise and distortion, EAR2 selected, linear mode selected (see Note 10)

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--|----------------------------|-----|-----|-----|------|
| Receive noise, (20-Hz to 20-kHz brickwall window) | PCMIN = 0000000000000 | | -86 | -83 | dBm0 |
| Receive signal-to-noise + distortion ratio with 1020-Hz sine-wave input | PCMIN to EAR2O at 3 dBm0 | 45 | 60 | | dB |
| | PCMIN to EAR2O at 0 dBm0 | 60 | 65 | | |
| | PCMIN to EAR2O at -5 dBm0 | 58 | 62 | | |
| | PCMIN to EAR2O at -10 dBm0 | 55 | 60 | | |
| | PCMIN to EAR2O at -20 dBm0 | 53 | 60 | | |
| | PCMIN to EAR2O at -30 dBm0 | 52 | 58 | | |
| | PCMIN to EAR2O at -40 dBm0 | 50 | 57 | | |
| | PCMIN to EAR2O at -45 dBm0 | 45 | 52 | | |
| Intermodulation distortion, 2-tone CCITT method, composite power level, -13 dBm0 | CCITT G.712 (7.1), R2 | 50 | | | dB |
| | CCITT G.712 (7.2), R2 | 54 | | | |

NOTE 10: RXPGA = -1 dB, RXVOL = 0 dB

power supply rejection and crosstalk attenuation

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|---|---|-----|-----|-----|------|
| Supply voltage rejection, transmit channel | MIC1N, MIC1P = 0 V, V _{DD} = 3 V _{dc} + 100 mV _{peak to peak} , f = 0 to 50 kHz | | -70 | -45 | dB |
| Supply voltage rejection, receive channel, EAR1 selected (differential) | PCM code = positive zero, V _{DD} = 3 V _{dc} + 100 mV _{peak to peak} , f = 0 to 50 kHz | | -70 | -45 | dB |
| Crosstalk attenuation, transmit-to-receive (differential) | MIC1N, MIC1P = 0 dB, f = 300 to 3400 Hz measured differentially between EAR1ON and EAR1OP | 70 | | | dB |
| Crosstalk attenuation, receive-to-transmit | PCMIN = 0 dBm0, f = 300 to 3400 Hz measured at PCMO, EAR1 amplifier | 70 | | | dB |

switching characteristics

clock timing requirements

| PARAMETER | MIN | NOM | MAX | UNIT |
|--|-----|-------|-----|------|
| t _t Transition time, MCLK | | | 10 | ns |
| f _{mclk} MCLK frequency | | 2.048 | | MHz |
| MCLK jitter | | | 37% | |
| Number of PCMCLK clock cycles per PCMSYN frame | 256 | | 256 | |
| t _c (PCMCLK) PCMCLK clock period | 156 | 488 | 512 | ns |
| Duty cycle, PCMCLK | 45% | 50% | 68% | |

transmit timing requirements (see Figure 5)

| PARAMETER | MIN | MAX | UNIT |
|--|-----|------------------------------|------|
| t _{su} (PCMSYN) Setup time, PCMSYN high before falling edge of PCMCLK | 20 | t _c (PCMCLK) - 20 | ns |
| t _h (PCMSYN) Hold time, PCMSYN high after falling edge of PCMCLK | 20 | t _c (PCMCLK) - 20 | |

switching characteristics (continued)
receive timing requirements (see Figure 6)

| PARAMETER | MIN | MAX | UNIT |
|---|-----|--------------------|------|
| $t_{su}(PCSYN)$ Setup time, PCMSYN high before falling edge of PCMCLK | 20 | $t_c(PCMCLK) - 20$ | ns |
| $t_h(PCSYN)$ Hold time, PCMSYN high after falling edge of PCMCLK | 20 | $t_c(PCMCLK) - 20$ | ns |
| $t_{su}(PCMI)$ Setup time, PCMI high or low before falling edge of PCMCLK | 20 | | ns |
| $t_h(PCMI)$ Hold time, PCMI high or low after falling edge of PCMCLK | 20 | | ns |

propagation delay times, $C_{L(max)} = 10$ pF (see Figure 5)

| PARAMETER | MIN | MAX | UNIT |
|--|-----|-----|------|
| t_{pd1} From PCMCLK bit 1 high to PCMO bit 1 valid | | 35 | ns |
| t_{pd2} From PCMCLK high to PCMO valid, bit 2 to n | | 35 | ns |
| t_{pd3} From PCMCLK bit n low to PCMO bit n Hi-Z | 30 | | ns |

I²C bus timing requirements (see Figure 7)

| PARAMETER | MIN | MAX | UNIT |
|--|------|-----|------|
| SCL Clock frequency | | 400 | kHz |
| t_{HIGH} Clock high time | 600 | | ns |
| t_{LOW} Clock low time | 1300 | | ns |
| t_r SDA and SCL rise time | | 300 | ns |
| t_f SDA and SCL fall time | | 300 | ns |
| $t_h(STA)$ Hold time (repeated) START condition. After this period the first clock pulse is generated. | 600 | | ns |
| $t_{su}(STA)$ Setup time for repeated START condition | 600 | | ns |
| $t_h(DAT)$ Data input hold time | 0 | | ns |
| $t_{su}(DAT)$ Data input setup time | 100 | | ns |
| $t_{su}(STO)$ STOP condition setup time | 600 | | ns |
| t_{BUF} Bus free time | 1300 | | ns |

DTMF generator characteristics

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|--|---|------|-----|-----|------|
| DTMF high to low tone relative amplitude (preemphasis) | | 1.5 | 2 | 2.5 | dB |
| Tone frequency accuracy | | -1.5 | | 1.5 | % |
| Harmonic distortion | Measured from lower tone group to highest parasitic | | | -20 | dB |

MICBIAS characteristics

| PARAMETER | TEST CONDITIONS | MIN | TYP | MAX | UNIT |
|----------------------------|-----------------|-----|-----|-----|------------|
| Load impedance (bias mode) | | | 5 | | k Ω |

PARAMETER MEASUREMENT INFORMATION

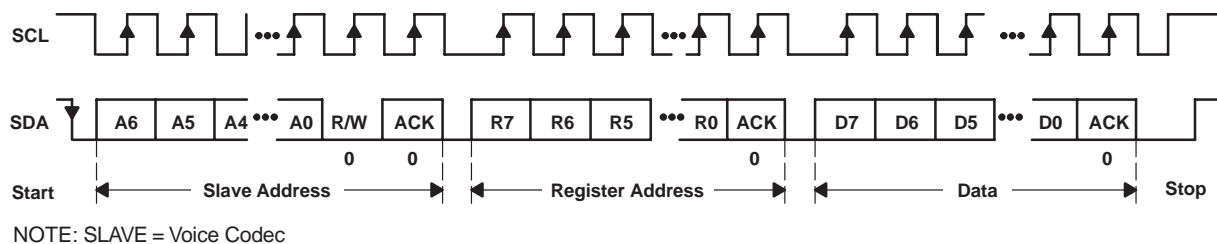


Figure 1. I²C-Bus Write to Voice Codec

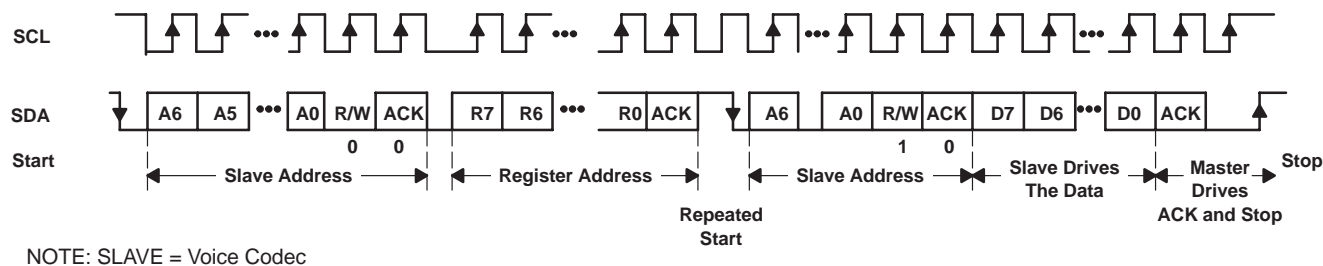


Figure 2. I²C Read From Voice Codec: Protocol A

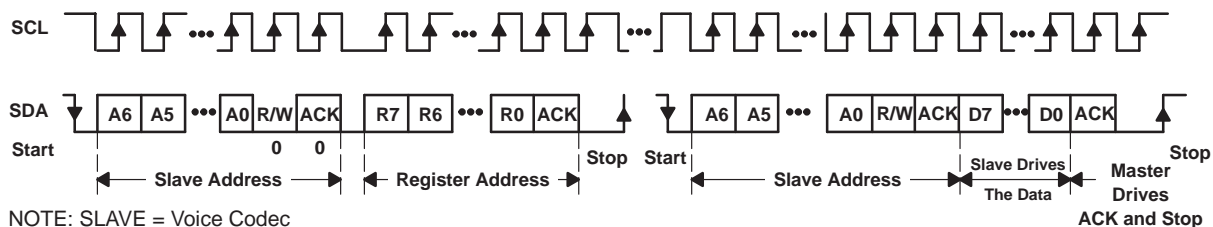


Figure 3. I²C Read From Voice Codec: Protocol B

PRINCIPLES OF OPERATION

power-on initialization

An external reset with a minimum pulse width of 500 ns must be applied to the active low $\overline{\text{RESET}}$ terminal to assure reset upon power on. All registers are set with default values upon external reset initialization.

The desired selection for all programmable functions can be initialized prior to a power-up command using the I²C interface.

Table 1. Power-Up and Power-Down Procedures ($V_{DD} = 2.7\text{ V}$, Earphone Amplifier Unloaded)

| DEVICE STATUS | PROCEDURE | MAXIMUM POWER CONSUMPTION |
|---------------|---|---------------------------|
| Power up | Set bit 1 = 1 in power control register, EAR1 enabled | 16.2 mW |
| | Set bit 1 = 0 in power control register, EAR2 enabled | 14.6 mW |
| Power down | Set bit 7 = 1 in TXPGA control register and bit 0 = 0 | 1.35 μW |
| | Set bit 7 = 0 in TXPGA control register and bit 0 = 0 | 67.5 μW |

In addition to resetting the power-down bit in the power control register, loss of MCLK (no transition detected) automatically enters the device into a power-down state with PCMO in the high impedance state. If during a pulse code modulation (PCM) data transmit cycle an asynchronous power down occurs, the PCM interface remains powered up until the PCM data is completely transferred.

An additional power-down mode overrides the MCLK detection function. This allows the device to enter the power-down state without regard to MCLK. Setting bit 7 of the TXPGA sidetone register to logic high enables this function.

conversion laws

The device can be programmed either for a 15-bit linear or 8-bit (μ -law or A-law) companding mode. The companding operation approximates the CCITT G.711 recommendation. The linear mode operation uses a 15-bit twos-complement format.

transmit operation

microphone input

The microphone input stage is a low noise differential amplifier that provides a preamplifier gain of 23.5 dB. A microphone can be capacitively connected to the MIC1N and MIC1P inputs, while the MIC2N and MIC2P inputs can be used to capacitively connect a second microphone or an auxiliary audio circuit.

PRINCIPLES OF OPERATION

transmit operation (continued)

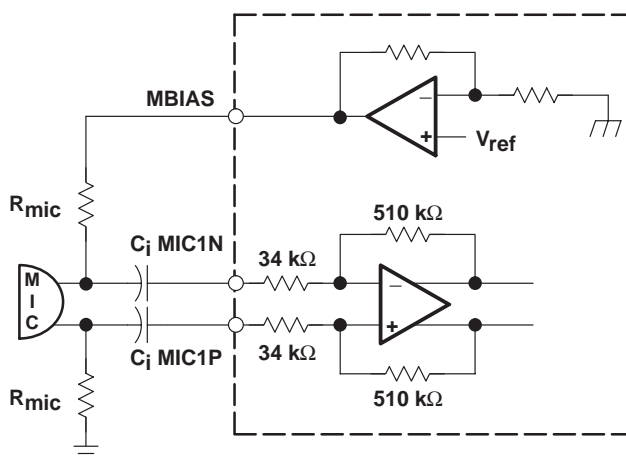


Figure 4. Typical Microphone Interface

microphone mute function

Transmit channel muting provides 80-dB attenuation of input microphone signal. The MICMUTE function can be selected by setting bit 6 of the power control register through the I²C interface.

transmit channel gain control

The values in the transmit PGA control registers control the gain in the transmit path. The total TX channel gain can vary from 35.5 dB to 13.5 dB. The default total TX channel gain is 23.5 dB.

Table 2. Transmit Gain Control

| BIT NAME | | | | MIC AMP1 | MIC AMP2 | TX PGA | GAIN MODE | TOTAL TX GAIN | | | |
|----------|-----|-----|-----|----------|----------|--------|-----------|---------------|------|------|------|
| TP3 | TP2 | TP1 | TP0 | GAIN | GAIN | GAIN | | MIN | TYP | MAX | UNIT |
| 0 | 0 | 0 | 0 | 23.5 | 12 | 0 | Extended | 35.3 | 35.5 | 35.7 | dB |
| 0 | 0 | 0 | 1 | 23.5 | 12 | -2 | Extended | 33.3 | 33.5 | 33.7 | dB |
| 0 | 0 | 1 | 0 | 23.5 | 12 | -4 | Extended | 31.3 | 31.5 | 31.7 | dB |
| 0 | 0 | 1 | 1 | 23.5 | 12 | -6 | Extended | 29.3 | 29.5 | 29.7 | dB |
| 0 | 1 | 0 | 0 | 23.5 | 12 | -8 | Extended | 27.3 | 27.5 | 27.7 | dB |
| 0 | 1 | 0 | 1 | 23.5 | 12 | -10 | Extended | 25.3 | 25.5 | 25.7 | dB |
| 1 | 0 | 0 | 0 | 23.5 | 0 | 0 | Normal | 23.3 | 23.5 | 23.7 | dB |
| 1 | 0 | 0 | 1 | 23.5 | 0 | -2 | Normal | 21.3 | 21.5 | 21.7 | dB |
| 1 | 0 | 1 | 0 | 23.5 | 0 | -4 | Normal | 19.3 | 19.5 | 19.7 | dB |
| 1 | 0 | 1 | 1 | 23.5 | 0 | -6 | Normal | 17.3 | 17.5 | 17.7 | dB |
| 1 | 1 | 0 | 0 | 23.5 | 0 | -8 | Normal | 15.3 | 17.5 | 17.7 | dB |
| 1 | 1 | 0 | 1 | 23.5 | 0 | -10 | Normal | 13.3 | 13.5 | 13.7 | dB |

PRINCIPLES OF OPERATION

receive operation

receive channel gain control

The values in the receive PGA control registers control the gain in the receive path. PGA gain is set from –6 dB to 6 dB in 1 dB steps through the I²C interface. The default receive channel gain is –1 dB.

Table 3. Receive PGA Gain Control

| BIT NAME | | | | RELATIVE GAIN | | | |
|----------|-----|-----|-----|---------------|-----|------|------|
| RP3 | RP2 | RP1 | RP0 | MIN | TYP | MAX | UNIT |
| 0 | 0 | 0 | 0 | 5.8 | 6 | 6.2 | dB |
| 0 | 0 | 0 | 1 | 4.8 | 5 | 5.2 | dB |
| 0 | 0 | 1 | 0 | 3.8 | 4 | 4.2 | dB |
| 0 | 0 | 1 | 1 | 2.8 | 3 | 3.2 | dB |
| 0 | 1 | 0 | 0 | 1.8 | 2 | 2.2 | dB |
| 0 | 1 | 0 | 1 | 0.8 | 1 | 1.2 | dB |
| 0 | 1 | 1 | 0 | –0.2 | 0 | 0.2 | dB |
| 0 | 1 | 1 | 1 | –1.2 | –1 | –0.8 | dB |
| 1 | 0 | 0 | 0 | –2.2 | –2 | –1.8 | dB |
| 1 | 0 | 0 | 1 | –3.2 | –3 | –2.8 | dB |
| 1 | 0 | 1 | 0 | –4.2 | –4 | –3.8 | dB |
| 1 | 0 | 1 | 1 | –5.2 | –5 | –4.8 | dB |
| 1 | 1 | 0 | 0 | –6.2 | –6 | –5.8 | dB |

sidetone gain control

The values in the sidetone PGA control registers control the sidetone gain. Sidetone gain is set from –12 dB to –24 dB in 2-dB steps through the I²C interface. Sidetone can be muted by setting bit 7 of the power control register. The default sidetone gain is –12 dB.

Table 4. Sidetone Gain Control

| BIT NAME | | | RELATIVE GAIN | | | |
|----------|-----|-----|---------------|-----|-------|------|
| ST2 | ST1 | ST0 | MIN | TYP | MAX | UNIT |
| 0 | 0 | 0 | –12.2 | –12 | –11.8 | dB |
| 0 | 0 | 1 | –14.2 | –14 | –13.8 | dB |
| 0 | 1 | 0 | –16.2 | –16 | –15.8 | dB |
| 0 | 1 | 1 | –18.2 | –18 | –17.8 | dB |
| 1 | 0 | 0 | –20.2 | –20 | –19.8 | dB |
| 1 | 0 | 1 | –22.2 | –22 | –21.8 | dB |
| 1 | 1 | 0 | –24.2 | –24 | –23.8 | dB |

PRINCIPLES OF OPERATION

receive operation (continued)

receive volume control

The values in the volume control PGA control registers provide volume control into the earphone. Volume control gain is set from 0 dB to –18 dB in 2-dB steps through the I²C interface. The default RX volume control gain is 0 dB.

Table 5. RX Volume Control

| BIT NAME | | | | RELATIVE GAIN | | | |
|----------|-----|-----|-----|---------------|-----|-------|------|
| RV3 | RV2 | RV1 | RV0 | MIN | TYP | MAX | UNIT |
| 0 | 0 | 0 | 0 | –0.2 | 0 | 0.2 | dB |
| 0 | 0 | 0 | 1 | –2.2 | –2 | –1.8 | dB |
| 0 | 0 | 1 | 0 | –4.2 | –4 | –3.8 | dB |
| 0 | 0 | 1 | 1 | –6.2 | –6 | –5.8 | dB |
| 0 | 1 | 0 | 0 | –8.2 | –8 | –7.8 | dB |
| 0 | 1 | 0 | 1 | –10.2 | –10 | –9.8 | dB |
| 0 | 1 | 1 | 0 | –12.2 | –12 | –11.8 | dB |
| 0 | 1 | 1 | 1 | –14.2 | –14 | –13.8 | dB |
| 1 | 0 | 0 | 0 | –16.2 | –16 | –15.8 | dB |
| 1 | 0 | 0 | 1 | –18.2 | –18 | –17.8 | dB |

earphone amplifier

The analog signal can be routed to either one of two earphone amplifiers: one with a differential output (EAR1ON and EAR1OP) capable of driving a 32-Ω load, or one with a single-ended output (EAR2O) capable of driving a 32-Ω load.

earphone mute function

Muting can be selected by setting bit 3 of the power control register through the I²C interface.

receive PCM data format

- Companded mode: 8 bits are received, the most significant (MSB) first.
- Linear mode: 15 bits are received, MSB first.

PRINCIPLES OF OPERATION

receive operation (continued)

Table 6. Receive-Data Bit Definitions

| BIT NO. | COMPANDED MODE | LINEAR MODE |
|---------|-------------------|----------------|
| 1 | CD7 | LD14 |
| 2 | CD6 | LD13 |
| 3 | CD5 | LD12 |
| 4 | CD4 | LD11 |
| 5 | CD3 | LD10 |
| 6 | CD2 | LD9 |
| 7 | CD1 | LD8 |
| 8 | CD0 | LD7 |
| 9 | – | LD6 |
| 10 | – | LD5 |
| 11 | – | LD4 |
| 12 | – | LD3 |
| 13 | – | LD2 |
| 14 | – | LD1 |
| 15 | – | LD0 |
| 16 | – | --- |

Transmit channel gain control bits always follow the PCM data in time:

CD7–CD0 = data word in companded mode

LD14–LD0 = data word in linear mode

DTMF generator operation and interface

The dual-tone multifrequency generator (DTMF) circuit generates the summed DTMF tones for push button dialing and provides the PDM output for the BUZZCON user-alert tone. The integer value is determined by the following formula, round tone [Freq (Hz)/7.8125 (Hz)]. The integer value is loaded into either one of two 8-bit registers, high-tone register (04) or low-tone register (05). The tone output is 2 dB higher when applied to the high-tone register (04). When generating DTMF tones, the high-frequency value must be applied to the high-tone register (04) and the low DTMF value to the low-tone register.

Table 7. Typical DTMF and Single Tone Control

| DT7 | DT6 | DT5 | DT4 | DT3 | DT2 | DT1 | DT0 | INTEGER VALUE | STONE FUNCTION | STONE/Hz |
|-----|-----|-----|-----|-----|-----|-----|-----|------------------|-------------------|----------|
| 0 | 1 | 0 | 1 | 1 | 0 | 0 | 1 | 89 | DTMF Low | 697 |
| 0 | 1 | 1 | 0 | 0 | 0 | 1 | 1 | 99 | DTMF Low | 770 |
| 0 | 1 | 1 | 0 | 1 | 1 | 0 | 1 | 109 | DTMF Low | 852 |
| 0 | 1 | 1 | 1 | 1 | 0 | 0 | 0 | 120 | DTMF Low | 941 |
| 1 | 0 | 0 | 1 | 1 | 0 | 1 | 1 | 155 | DTMF High | 1209 |
| 1 | 0 | 1 | 0 | 1 | 0 | 1 | 1 | 171 | DTMF High | 1336 |
| 1 | 0 | 1 | 1 | 1 | 1 | 0 | 1 | 189 | DTMF High | 1477 |
| 1 | 1 | 0 | 1 | 0 | 0 | 0 | 1 | 209 | DTMF High | 1633 |

PRINCIPLES OF OPERATION

DTMF generator operation and interface (continued)

Tones from the DTMF generator block are present at all outputs and are controlled by enabling or disabling the individual output ports. The values that determine the tone frequency are loaded into the tone registers (high and low) as two separate values.

The values loaded into the tone registers initiate an iterative table look-up function, placing a 6-bit or 7-bit in 2s complement value into the tone registers. There is a 2 dB difference in the resulting output of the two registers, the high tone register having the greater result.

buzzer logic section

The single-ended output BUZZCON is a PDM signal intended to drive a buzzer through an external driver transistor. The PDM begins as a selected DTMF tones, generated and passed through the receive D/A channel, and fed back to the transmit channel analog modulator, where a PDM signal is generated and routed to the BUZZCON output.

support section

The clock generator and control circuit use the master clock input (MCLK) to generate internal clocks to drive internal counters, filters, and convertors. Register control data is written into and read back from the PCM codec registers via the control interface.

I²C-bus protocols

The PCM codec serial interface is designed to be I²C-bus compatible and operates in the slave mode. This interface consists of the following terminals:

- SCL: I²C-bus serial clock — This input synchronizes the control data transfer from and to the codec.
- SDA: I²C-bus serial address/data input/output — This is a bidirectional terminal that transfers register control addresses and data into and out of the codec. It is an open drain terminal and therefore requires a pullup resistor to V_{CC} (typical 10 kΩ for 100 kHz).

TLV320AIC1109 has a fixed device select address of {E2}HEX for write mode and {E3}HEX for read mode.

For normal data transfer, SDA is allowed to change only when SCL is low. Changes when SCL is high are reserved for indicating the start and stop conditions.

Data transfer may be initiated only when the bus is not busy. During data transfer, the data line must remain stable whenever the clock line is at high. Changes in the data line while the clock line is at high are interpreted as a start or stop condition.

Table 8. I²C-Bus Conditions

| CONDITION | STATUS | DESCRIPTION |
|-----------|---------------------|--|
| A | Bus not busy | Both data and clock lines remain at high |
| B | Start data transfer | A high-to-low transition of the SDA line while the clock (SCL) is high determines a start condition. All commands must proceed from a start condition. |
| C | Stop data transfer | A low-to-high transition of the SDA line while the clock (SCL) is high determines a stop condition. All operations must end with a stop condition. |
| D | Data valid | The state of the data line represents valid data when, after a start condition, the data line is stable for the duration of the high period of the clock signal. |

PRINCIPLES OF OPERATION

I²C bus protocols

The data on the line must be changed during the low period of the clock signal. There is one clock pulse per bit of data.

Each data transfer is initiated with a start condition and terminated with a stop condition. The number of data bytes, transferred between the start and stop conditions, is determined by the master device (microprocessor).

When addressed, the PCM codec generates an acknowledge after the reception of each byte. The master device must generate an extra clock pulse that is associated with this acknowledge bit.

The PCM codec must pull down the SDA line during the acknowledge clock pulse so that the SDA line is at stable low state during the high period of the acknowledge related clock pulse. Setup and hold times must be taken into account. During read operations, the master device must signal an end of data to the slave by not generating an acknowledge bit on the last byte that was clocked out of the slave. In this case, the slave (PCM codec) must leave the data line high to enable the master device to generate the stop condition.

clock frequencies and sample rates

A fixed PCMSYN rate of 8 kHz determines the sampling rate.

register map addressing

| | REG | 07 | 06 | 05 | 04 | 03 | 02 | 01 | 00 |
|---------------|-----|-------------|-------------|-------------|-------------|-------------|-------------|-------------|-------------|
| Power control | 00 | Sidetone En | TXEn | RXEn | MICSEL | BIASEn | RXEn | EAROUT Sel | PWRUP |
| Mode control | 01 | Comp Sel | TMEEn | PCMLB | Comp En | BUZZEn | RXFLTR En | TXFLTR En | TXSLOPE En |
| TXPGA | 02 | PD0 | TP3 | TP2 | TP1 | TP0 | ST2 | ST1 | ST0 |
| RXPGA | 03 | RP3 | RP2 | RP1 | RP0 | RV3 | RV2 | RV1 | RV0 |
| High DTMF | 04 | HIFREQ Sel7 | HIFREQ Sel6 | HIFREQ Sel5 | HIFREQ Sel4 | HIFREQ Sel3 | HIFREQ Sel2 | HIFREQ Sel1 | HIFREQ Sel0 |
| Low DTMF | 05 | LOFREQ Sel7 | LOFREQ Sel6 | LOFREQ Sel5 | LOFREQ Sel4 | LOFREQ Sel3 | LOFREQ Sel2 | LOFREQ Sel1 | LOFREQ Sel0 |

register power-up defaults

| | REG | 07 | 06 | 05 | 04 | 03 | 02 | 01 | 00 |
|----------------------------|-----|----|----|----|----|----|----|----|----|
| Power control [†] | 00 | 1 | 1 | 1 | 1 | 0 | 1 | 1 | 0 |
| Power control [‡] | 00 | 1 | 0 | 0 | 1 | 1 | 0 | 1 | 1 |
| Mode control | 01 | 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 |
| TXPGA | 02 | 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 |
| RXPGA | 03 | 0 | 1 | 1 | 1 | 0 | 0 | 0 | 0 |
| High DTMF | 04 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |
| Low DTMF | 05 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 |

[†] Value when PWRUPSEL = 0

[‡] Value when PWRUPSEL = 1

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register map

Table 9. Power Control Register: Address {00} HEX

| BIT NUMBER | | | | | | | | DEFINITIONS |
|------------|---|---|---|---|---|---|---|--|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| 1 | 1 | 1 | 1 | 0 | 1 | 1 | 0 | Default setting PWRUPSEL = 0 |
| 1 | 0 | 0 | 1 | 1 | 0 | 1 | 1 | Default setting PWRUPSEL = 1 |
| X | X | X | X | X | X | X | 0 | Reference system, power-down |
| X | X | X | X | X | X | X | 1 | Reference system, power-up |
| X | X | X | X | X | X | 1 | X | EAR AMP1 selected, EAR AMP2 power down |
| X | X | X | X | X | X | 0 | X | EAR AMP2 selected, EAR AMP1 power down |
| X | X | X | X | X | 0 | X | X | Receive channel enabled |
| X | X | 0 | X | X | 1 | X | X | Receive channel muted |
| X | X | 1 | X | X | 1 | X | 0 | Receive channel, power down |
| X | X | X | 1 | X | X | X | X | MIC1 selected |
| X | X | X | 0 | X | X | X | X | MIC2 selected |
| X | 0 | X | X | X | X | X | X | Transmit channel enabled |
| X | 1 | 0 | X | X | X | X | X | Transmit channel muted |
| X | 1 | 1 | X | X | X | X | X | Transmit channel power down |
| 0 | X | X | X | X | X | X | X | Sidetone enabled |
| 1 | X | X | X | X | X | X | X | Sidetone muted |

Table 10. Mode Control Register: Address {01} HEX

| BIT NUMBER | | | | | | | | DEFINITIONS |
|------------|---|---|---|---|---|---|---|--|
| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | |
| 0 | 0 | 0 | 0 | 0 | 0 | 1 | 0 | Default setting |
| X | X | X | X | X | X | 0 | 0 | TX channel high-pass filter enabled and slope filter enabled |
| X | X | X | X | X | X | 0 | 1 | TX channel high-pass filter enabled and slope filter disabled |
| X | X | X | X | X | X | 1 | 0 | TX channel high-pass filter disabled and slope filter enabled |
| X | X | X | X | X | X | 1 | 1 | TX channel high-pass filter disabled and slope filter disabled |
| X | X | X | X | X | 0 | X | X | RX channel high-pass filter disabled (low pass only) |
| X | X | X | X | X | 1 | X | X | RX channel high-pass filter enabled |
| X | X | X | X | 0 | X | X | X | BUZZCON disabled |
| X | X | X | X | 1 | X | X | X | BUZZCON enabled |
| X | X | X | 0 | X | X | X | X | Linear mode selected |
| 1 | X | X | 1 | X | X | X | X | A-law companding mode selected |
| 0 | X | X | 1 | X | X | X | X | μ-law companding mode selected |
| X | X | 0 | X | X | X | X | X | TX and RX channels normal mode |
| X | X | 1 | X | X | X | X | X | PCM loopback mode |
| X | 0 | X | X | X | X | X | X | Tone mode disabled |
| X | 1 | X | X | X | X | X | X | Tone mode enabled |

PRINCIPLES OF OPERATION

register map (continued)

Transmit PGA and sidetone control register: Address {02}HEX

Bit definitions :

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | DEFINITION |
|-----|-----|-----|-----|-----|-----|-----|-----|-------------------------|
| PDO | TP3 | TP2 | TP1 | TP0 | ST2 | ST1 | ST0 | See Table 2 and Table 4 |
| 0 | 1 | 0 | 0 | 0 | 0 | 0 | 0 | Default setting |

Receive volume control register: Address {03}HEX

Bit definitions :

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | DEFINITION |
|-----|-----|-----|-----|-----|-----|-----|-----|-------------------------|
| RP3 | RP2 | RP1 | RP0 | RV3 | RV2 | RV1 | RV0 | See Table 3 and Table 5 |
| 0 | 1 | 1 | 1 | 0 | 0 | 0 | 0 | Default setting |

High tone selection control register: Address {04}HEX

Bit definitions :

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | DEFINITION |
|---|---|---|---|---|---|---|---|--------------------|
| X | X | X | X | X | X | X | X | DTMF (see Table 7) |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | Default setting |

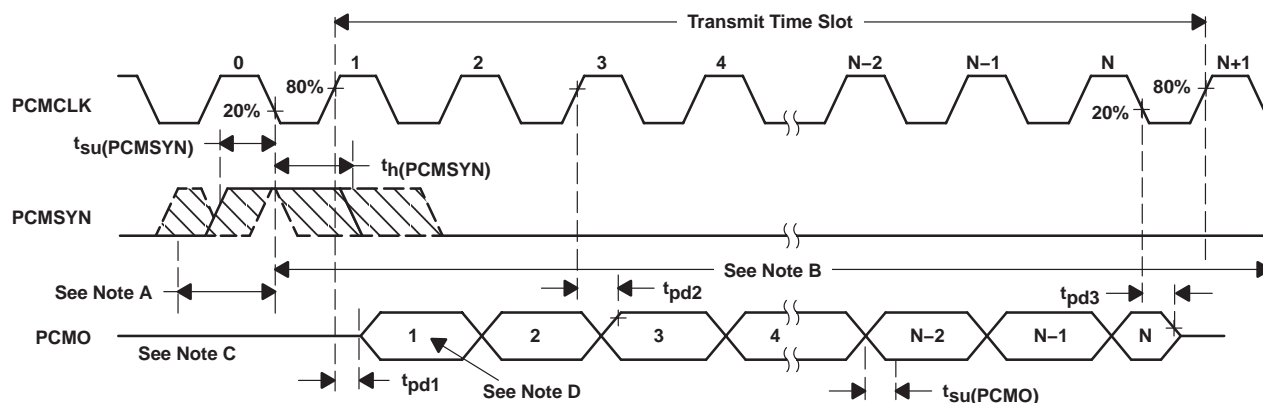
Low tone selection control register: Address {05}HEX

Bit definitions :

| 7 | 6 | 5 | 4 | 3 | 2 | 1 | 0 | DEFINITION |
|---|---|---|---|---|---|---|---|--------------------|
| X | X | X | X | X | X | X | X | DTMF (see Table 7) |
| 0 | 0 | 0 | 0 | 0 | 0 | 0 | 0 | Default setting |

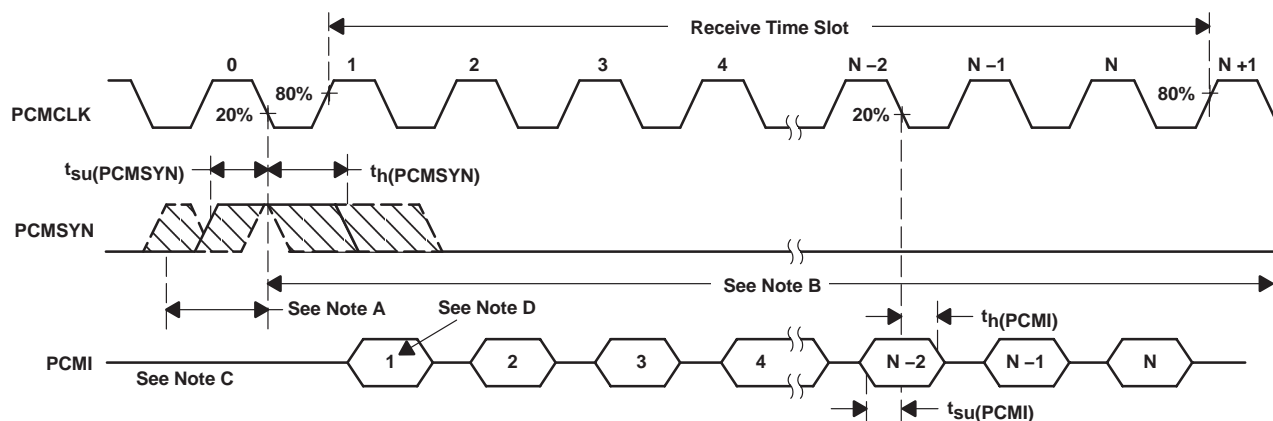
PRINCIPLES OF OPERATION

register map (continued)



- NOTES: A. This window is allowed for PCMSYN high.
 B. This window is allowed for PCMSYN low ($t_h(PCMSYN)$ max determined by data collision considerations).
 C. Transitions are measured at 50%.
 D. Bit 1 = MSB, Bit N = LSB

Figure 5. Transmit Timing Diagram



- NOTES: A. This window is allowed for PCMSYN high.
 B. This window is allowed for PCMSYN low.
 C. Transitions are measured at 50%.
 D. Bit 1 = MSB, Bit N = LSB

Figure 6. Receive Timing Diagram

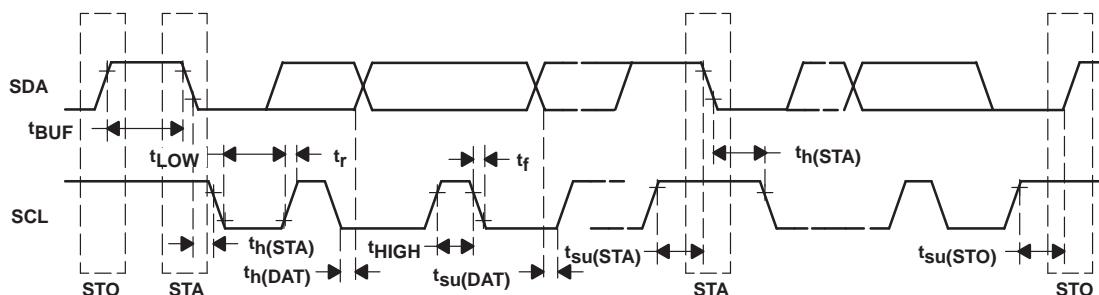
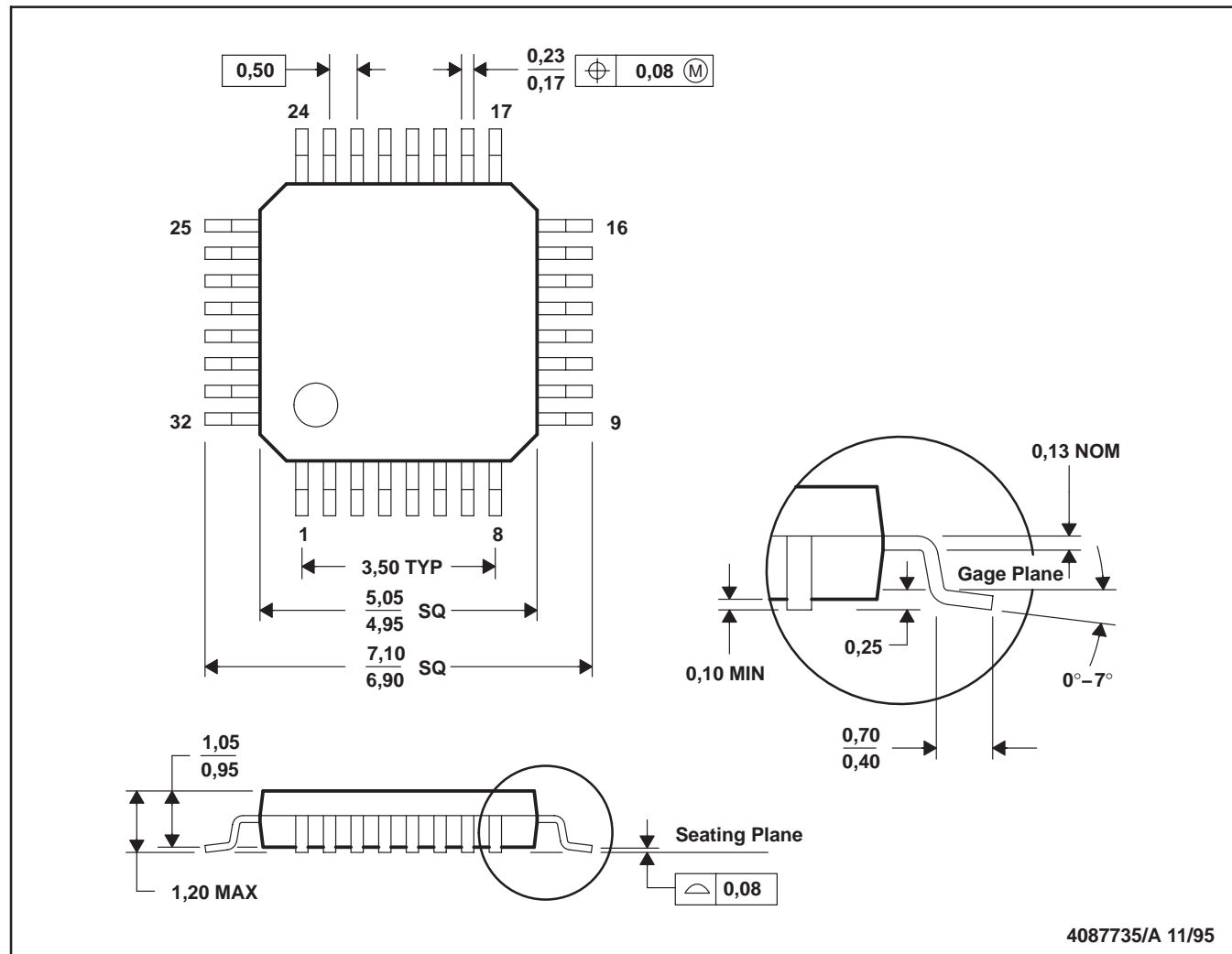


Figure 7. I²C-Bus Timing Diagram

MECHANICAL DATA

PBS (S-PQFP-G32)

PLASTIC QUAD FLATPACK



NOTES: A. All linear dimensions are in millimeters.
B. This drawing is subject to change without notice.

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead/Ball Finish (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|-------------------------|----------------------|--------------|-------------------------|---------|
| TLV320AIC1109PBS | OBSOLETE | TQFP | PBS | 32 | | TBD | Call TI | Call TI | -40 to 85 | AIC1109 | |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) Eco Plan - The planned eco-friendly classification: Pb-Free (RoHS), Pb-Free (RoHS Exempt), or Green (RoHS & no Sb/Br) - please check <http://www.ti.com/productcontent> for the latest availability information and additional product content details.

TBD: The Pb-Free/Green conversion plan has not been defined.

Pb-Free (RoHS): TI's terms "Lead-Free" or "Pb-Free" mean semiconductor products that are compatible with the current RoHS requirements for all 6 substances, including the requirement that lead not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, TI Pb-Free products are suitable for use in specified lead-free processes.

Pb-Free (RoHS Exempt): This component has a RoHS exemption for either 1) lead-based flip-chip solder bumps used between the die and package, or 2) lead-based die adhesive used between the die and leadframe. The component is otherwise considered Pb-Free (RoHS compatible) as defined above.

Green (RoHS & no Sb/Br): TI defines "Green" to mean Pb-Free (RoHS compatible), and free of Bromine (Br) and Antimony (Sb) based flame retardants (Br or Sb do not exceed 0.1% by weight in homogeneous material)

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

(6) Lead/Ball Finish - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead/Ball Finish values may wrap to two lines if the finish value exceeds the maximum column width.

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